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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









ZDT1048 SM-8 Dual NPN medium power high gain transistors

Summary

 $BV_{CEO} > 17.5V$

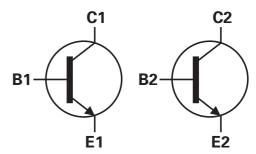
 $I_{C(cont)} = 5A$

V_{CE(sat)} < 75mV @ 1A

 $P_{D} = 2.75W$



Advanced process capability has been used to achieve this high performance device. Combining two NPN transistors in the SM-8 package provides a compact solution for the intended applications.



Features

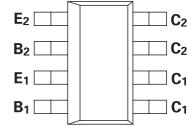
- · Dual NPN device
- · Very low saturation voltage
- · High gain
- SM 8 package

Applications

- · CCFL invertors
- Royer circuits

Ordering information

DEVICE	Reel size (inches)	Tape width (mm)	Quantity per reel	
ZDT1048TA	7	12	1000	



Device marking

T1048

Absolute maximum ratings

Parameter	Symbol	Value	Unit	
Collector-base voltage	V _{CBO}	50	V	
Collector-emitter voltage	V _{CEO}	17.5	V	
Emitter-base voltage	V _{EBO}	5	V	
Peak pulse current	I _{CM}	20	Α	
Continuous collector current	I _C	5	Α	
Base current	I _B	500	mA	
Operating and storage temperature range	T _j :T _{stg}	-55 to +150	°C	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Total power dissipation at T _{amb} = 25°C*	P _{tot}		
Any single die "on"		2.25	W
Both die "on" equally		2.75	W
Derate above 25°C*			V
Any single die "on"		18	mW/°C
Both die "on" equally		22	mW/°C
Thermal resistance - junction to ambient*			
Any single die "on"		55.6	°C/W
Both die "on" equally		45.5	°C/W

^{*} The power which can be dissipated assuming the device is mounted in a typical manner on a PCB with copper equal to 2 inches square.

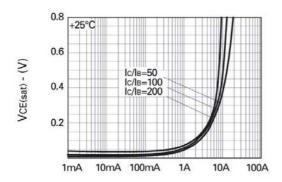
Electrical characteristics (at $T_{amb} = 25$ °C unless otherwise stated).

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Collector-base breakdown voltage	V _{(BR)CBO}	50	85		V	I _C =100μA
Collector-emitter breakdown voltage	V _{CES}	50	85		V	I _C =100μA
Collector-emitter breakdown voltage	V _{CEO}	17.5	24		V	I _C =10mA
Collector-emitter breakdown voltage	V _{CEV}	50	85		V	I _C =100μA, V _{EB} =1V
Emitter-base breakdown voltage	V _{(BR)EBO}	5	8.7		V	I _E =100μA
Collector cut-off current	I _{CBO}		0.3	10	nA	V _{CB} =35V
Emitter cut-off current	I _{EBO}		0.3	10	nA	V _{EB} =4V
Collector-emitter cut-off current	I _{CES}		0.3	10	nA	I _{CES} =35V
Collector-emitter saturation voltage	V _{CE(sat)}		27 55 120 200 200	45 75 160 240 300	mV mV mV mV	I _C =0.5A, I _B =10mA (*) I _C =1A, I _B =10mA(*) I _C =2A, I _B =10mA(*) I _C =5A, I _B =100mA(*) I _C =5A, I _B =50mA(*)
Base-emitter saturation voltage	V _{BE(sat)}		1000	1100	mV	I _C =5A, I _B =100mA ^(*)
Base-emitter turn on voltage	V _{BE(on)}		900	1000	mV	I _C =5A, V _{CE} =2V ^(*)
Static forward current transfer ratio	h _{FE}	280 300 300 250 50	440 450 450 300 80	1200		I _C =10mA, V _{CE} =2V ^(*) I _C =0.5A, V _{CE} =2V ^(*) I _C =1A, V _{CE} =2V ^(*) I _C =5A, V _{CE} =2V ^(*) I _C =20A, V _{CE} =2V ^(*)
Transition frequency	f _T		150		MHz	I _C =50mA, V _{CE} =10V f=50MHz
Output capacitance	C _{obo}		60	80	pF	V _{CB} =10V, f=1MHz
Switching times	t _{on}		120		ns	I _C =4A, I _B =40mA,V _{CC} =10V
	t _{off}		250		ns	I _C =4A, I _B =±40mA,V _{CC} =10V

NOTES:

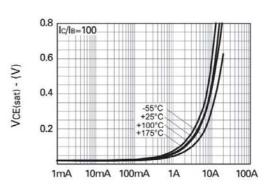
(*) Measured under pulsed conditions. Pulse width=300 μ s. Duty cycle $\leq 2\%$

Typical characteristics



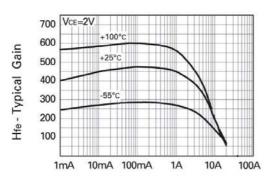
IC-Collector Current

VCE(sat) v IC



IC-Collector Current

VCE(sat) v IC



IC-Collector Current

hfe v lc

1.00 °C +100°C +175°C 0.6 0.6 0.4 0.2 100 A 100

Ic/IB=100

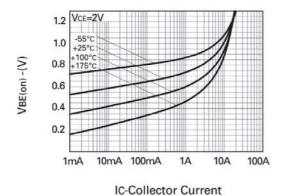
-55°C

1.2

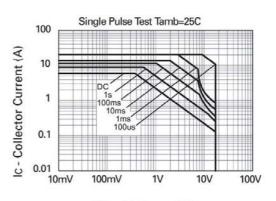
1.0

IC-Collector Current

VBE(sat) v Ic



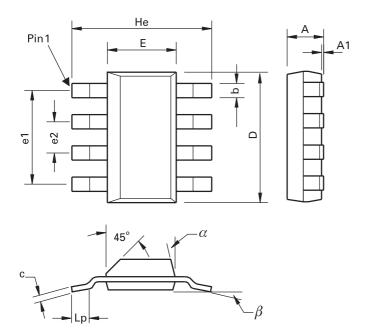
VBE(on) v IC



VCE - Collector Voltage

Safe Operating Area

Package outline - SM8



DIM	N	/lillimete	rs	Inches		DIM	DIM Millimeters		rs	Inches			
	Min.	Max.	Тур.	Min.	Max.	Тур.		Min.	Max.	Тур.	Min.	Max.	Тур.
Α	-	1.7	-	-	0.067	-	e1	-	-	4.59	-	-	0.1807
A1	0.02	0.1	-	0.0008	0.004	-	e2	-	-	1.53	-	-	0.0602
b	-	-	0.7	-	-	0.0275	He	6.7	7.3	-	0.264	0.287	-
С	0.24	0.32	-	0.009	0.013	-	Lp	0.9	-	-	0.035	-	-
D	6.3	6.7	-	0.248	0.264	-	α	-	15°	-	-	15°	-
Е	3.3	3.7	-	0.130	0.145	-	β	-	-	10°	-	-	10°

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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 - 1. are intended to implant into the body

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Zetex sales offices

Europe	Americas	Asia Pacific	Corporate Headquarters
Zetex GmbH Kustermann-park Balanstraße 59 D-81541 München Germany	Zetex Inc 700 Veterans Memorial Highway Hauppauge, NY 11788 USA	Zetex (Asia Ltd) 3701-04 Metroplaza Tower 1 Hing Fong Road, Kwai Fong Hong Kong	Zetex Semiconductors plc Zetex Technology Park, Chadderton Oldham, OL9 9LL United Kingdom
Telefon: (49) 89 45 49 49 0 Fax: (49) 89 45 49 49 49 europe.sales@zetex.com	Telephone: (1) 631 360 2222 Fax: (1) 631 360 8222 usa.sales@zetex.com	Telephone: (852) 26100 611 Fax: (852) 24250 494 asia.sales@zetex.com	Telephone: (44) 161 622 4444 Fax: (44) 161 622 4446 hq@zetex.com

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